

# 產品規格書

# **Market Requirement Document**

	CUSTO	MER:								
PRODUCT:			声表面谐振器							
MODEL:			F11-R315M							
PARAMETER:		R315								
DATE:		ZR315M								
ल्ट केला ८८ <del>के हे होते</del> <i>M</i>										
	承	認後請寄回	可一伤	<b>子</b>						
PLEASE R	ETURN ONE CO	OPY TO US SO T	HAT W	E GET YOUF	R APPROVAL					
承認結果	客戶簽名	客戶承認章	È	日期	備注					
CONCLUSION	SIGNATURE	STAMP		DATE	REMARK					
合格										
ACCEPT										
不合格										
REJECT										
				_						
制表: 钟先生			审核:							
			1 121*		(公章)					
尊敬的客户:请您抽出	出一点时间,在7-10个上	工作日内将承认书回签	, 若未回签	,以视默认.谢谢台	<i>合作!</i>					

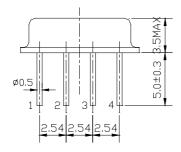
## 1. Package Dimension

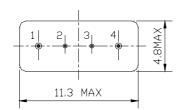
(F-11)

Unit:

mm







Pin No. Function

- 1. Input
- 2. Ground
- 3. Ground
- 4. Output

# 2. Marking

'""""\ Z 315.00

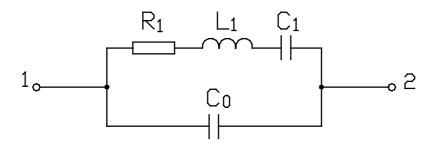
1. Color: Black or Blue

2. DR: Manufacture's logo

3. 1: One-port SAW Resonator

4. 315.00: Center Frequency (MHz)

# 3. Equivalent LC Model



## 4. Performance

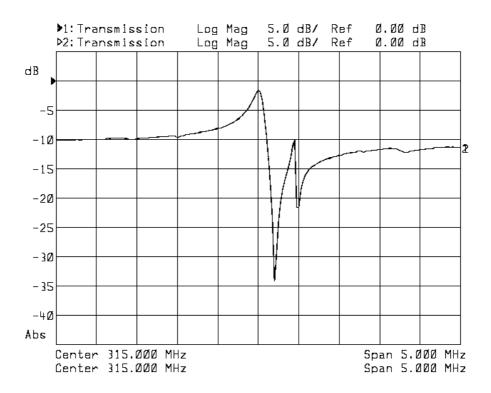
## 4.1 Maximum Rating

DC Voltage V <sub>DC</sub>	10V		
AC Voltage V <sub>PP</sub>	10V (50Hz/60Hz)		
Operation Temperature	-40 °C to +85°C		
Storage Temperature	-45 °C to +85°C		
RF Power Dissipation	0dBm		

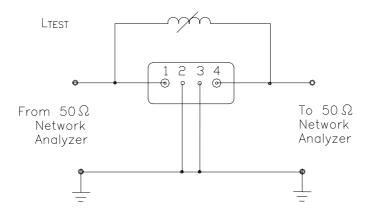
## 4.2 Electronic Characteristics

Item		Units	Minimum	Typical	Maximum
Center Frequency fo		MHz	314.925	315	315.075
Insertion Loss		dB	_	1.3	2.5
Quality Factor	Unloaded Q	_	_	12,000	_
	50Ω Loaded Q			1,900	
Tem perature	Turnover Temperature	$^{\circ}$ C	10	25	40
Stability	Turnover Frequency	KHz	_	fo	_
	Freq.Temp.Coefficient	ppm/°C²	_	0.037	_
Frequency Aging		ppm/yr	_	<±10	_
DC Insulation Resistance		ΜΩ	1.0	_	_
RF Equivalent RLC Model	Motional Resistance R <sub>1</sub>	Ω	_	23	29
	Motional Inductance L <sub>1</sub>	μН		115.2	
	Motional Capacitance C <sub>1</sub>	fF	_	2.2	_
	Shunt Static Capacitance C <sub>O</sub>	pF	2.1	2.4	2.7

## 4.3 Frequency Characteristics



### 4.4 Test Circuit



Note: Reference temperature shall be  $25\pm2^{\circ}$ C. However, the measurement may be carried out at  $5^{\circ}$ C to  $35^{\circ}$ C unless there is a dispute.

## 5. Reliability

- 5.1 Mechanical Shock: The components shall remain within the electrical specifications after 1000 shocks, acceleration 392 m/s<sup>2</sup>, duration 6 milliseconds.
- 5.2 Vibration Fatigue: The components shall remain within the electrical specifications after loaded vibration at 20 Hz, amplitude 1.5 mm, for 2 hours.
- 5.3 Terminal Strength: The components shall remain within the electrical specifications after pulled 2 kgs weight for 10 seconds towards an axis of each terminal.
- 5.4 High Temperature Storage: The components shall remain within the electrical specifications after being kept at the  $85^{\circ}$ C  $\pm 2^{\circ}$ C for 48 hours, then kept at room temperature for 2 hours.
- 5.5 Low Temperature Storage: The components shall remain within the electrical specifications after being kept at the -25°C  $\pm$ 2°C for 48 hours, then kept at room temperature for 2 hours.
- 5.6 Temperature Cycle: The components shall remain within the electrical specifications after 5 cycles of high and low temperature testing (one cycle: 80°C for 30 minutes → 25°C for 30 minutes) than kept at room temperature for 2 hours.
- 5.7 Solder-heat Resistance: The components shall remain within the electrical specifications after dipped in the solder at 260°C for  $10\pm1$  seconds, then kept at room temperature for 2 hours. (Terminal must be dipped leaving 1.5 mm from the case).
- 5.8 Solderability: Solderability of terminal shall be kept at more than 80% after dipped in the solder flux at  $230^{\circ}\text{C} \pm 5^{\circ}\text{C}$  for  $5\pm 1$  seconds.

#### 6. Remarks

#### 6.1 Static voltage

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.

#### 6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning.

#### 6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.